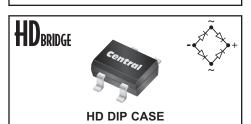
CBRHD SERIES

SURFACE MOUNT SILICON HIGH DENSITY 0.5 AMP BRIDGE RECTIFIER





www.centralsemi.com

DESCRIPTION:

The CENTRAL SEMICONDUCTOR CBRHD series devices are silicon full wave bridge rectifiers mounted in a durable epoxy surface mount molded case, utilizing glass passivated chips.

MARKING CODES:

CBRHD-02: CBD2 CBRHD-04: CBD4 CBRHD-10: CBD10

FEATURES:

 Efficient use of board space: requires only 42mm² of board space vs. 120mm² of board space needed for industry standard 1.0 Amp surface mount bridge rectifier.

- 50% higher density (Amps/mm²) than the industry standard 1.0 Amp surface mount bridge rectifier.
- · Glass passivated chips for high reliability.

MAXIMUM RATINGS : (T _A =25°C unless otherwise noted)		CBRHD				
	SYMBOL	- <u>02</u>	<u>-04</u>	<u>-06</u>	<u>-10*</u>	UNITS
Peak Repetitive Reverse Voltage	V_{RRM}	200	400	600	1000	V
DC Blocking Voltage	V_{R}	200	400	600	1000	V
RMS Reverse Voltage	V _R (RMS)	140	280	420	700	V
Average Forward Current (T _A =40°C) (Note 1)	IO	0.5			Α	
Average Forward Current (T _A =40°C) (Note 2)	IO	0.8			Α	
Peak Forward Surge Current	IFSM	30			Α	
Operating & Storage Junction Temperature	T _J , T _{stg}		-65 t	o +150		°C

ELECTRICAL CHARACTERISTICS PER DIODE: (T_A=25°C unless otherwise noted)

SYMBOL	TEST CONDITIONS	TYP	MAX	UNITS
I_{R}	V _R =Rated V _{RRM}		5.0	μΑ
I_{R}	V _R =Rated V _{RRM} , T _A =125°C		500	μΑ
V_{F}	I _F =400mA		1.0	V
СЈ	V _R =4.0V, f=1.0MHz	20		pF

Notes: (1) Mounted on Glass-Epoxy PCB. (2) Mounted on Ceramic PCB.

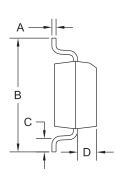
^{*} Available on special order, please consult factory.

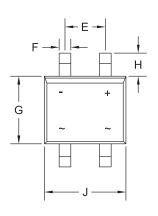
CBRHD SERIES

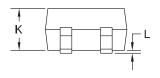
SURFACE MOUNT SILICON HIGH DENSITY 0.5 AMP BRIDGE RECTIFIER



HD DIP CASE - MECHANICAL OUTLINE







R2

MARKING CODES: CBRHD-02: CBD2 CBRHD-04: CBD4 CBRHD-06: CBD6 CBRHD-10: CBD10

DIMENSIONS							
	INCHES		MILLIMETERS				
SYMBOL	MIN	MAX	MIN	MAX			
Α	0.006	0.014	0.15	0.35			
В	-	0.275	-	7.00			
С	0.027	0.043	0.70	1.10			
D	0.035	0.051	0.90	1.30			
E	0.090	0.106	2.30	2.70			
F	0.019	0.031	0.50	0.80			
G	0.150	0.165	3.80	4.20			
Н	0.051	0.067	1.30	1.70			
J	0.177	0.193	4.50	4.90			
K	0.090	0.106	2.30	2.70			
Ĺ	0.000	0.008	0.00	0.20			

HD DIP (REV: R2)

R5 (18-February 2016)

OUTSTANDING SUPPORT AND SUPERIOR SERVICES



PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- · Inventory bonding
- · Consolidated shipping options

- · Custom bar coding for shipments
- · Custom product packing

DESIGNER SUPPORT/SERVICES

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free guick ship samples (2nd day air)
- Online technical data and parametric search
- SPICE models
- · Custom electrical curves
- · Environmental regulation compliance
- · Customer specific screening
- · Up-screening capabilities

- Special wafer diffusions
- PbSn plating options
- Package details
- Application notes
- · Application and design sample kits
- Custom product and package development

REQUESTING PRODUCT PLATING

- 1. If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
- 2. If requesting Lead (Pb) Free plated devices, add the suffix "PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

CONTACT US

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